

For lease

OPC Campus 970 Woodland Ave. Columbus, Ohio 43219

Property overview

Property specifications

- up to 87,245 s.f. available
 - o 5,490 s.f. office
 - 81,755 s.f. warehouse
- 13.9' 22.9' clear height
- 2 dock doors
- Wet fire suppression system
- Heavy 480V electric
- AC in office and heat throughout building
- Column spacing: 20' 50'
- Ample trailer parking available

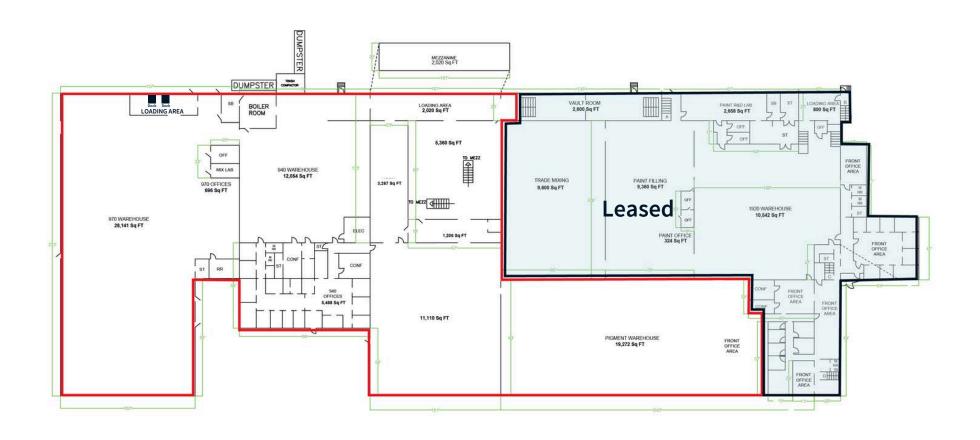
Advantages and amenities

- Less than 1 mile to I 670, 3 miles to
 I-71, and 4 miles to I-70
- Close proximity (5 minutes) to Columbus Business District and John Glenn Columbus International Airport

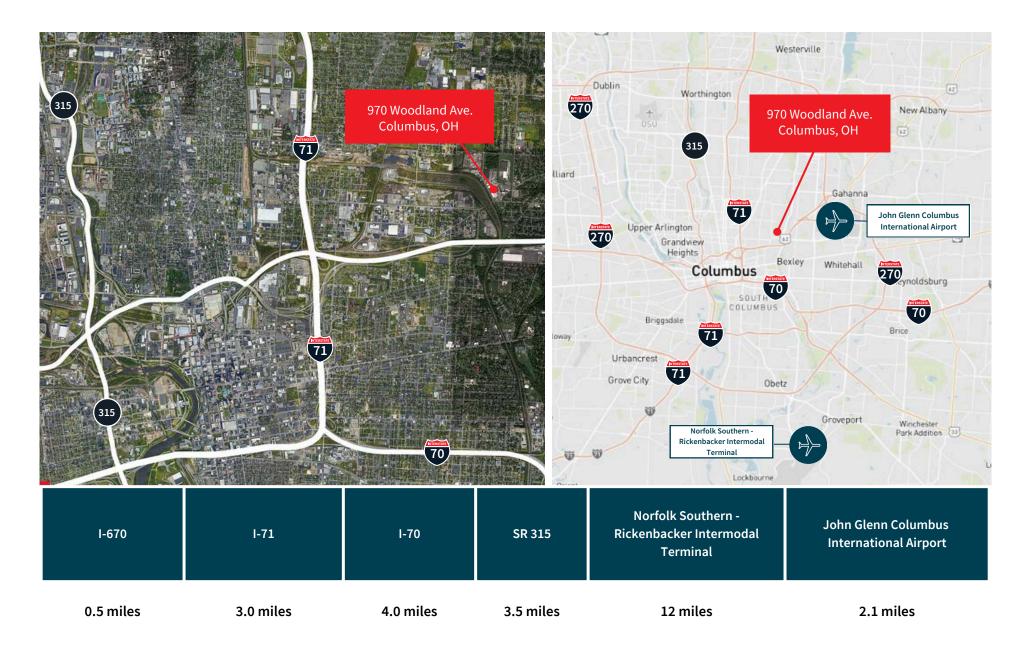




Floorplan



Access



Property overview

419,481 SF on 30+ acres

##	Address	Building SF	SF available now	Future availability
1	1100 Woodland Ave	106,228	48,025	• 43,000 SF available on 06/01/2026
2	1040 Woodland Ave	12,213	0	• 12,213 SF available on 7/1/2025
3	1920 Leonard - 970 Woodland Ave	258,000	87,245	• 53,900 SF available on 6/01/2026
4	2604 Leonard Ave	5,300	0	• 5,300 SF available on 06/01/2026
5a		6,720		
5b	1920 Leonard Ave	6,720	0	• 19,640 SF available on 6/01/2026
5c		6,200		
6	2004 Leonard Ave.	18,100	18,100 SF (available over two floors)	







JLL

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